TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HC390AFN

Dual Decade Counter

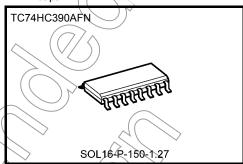
The TC74HC390A is a high speed CMOS DUAL DECADE COUNTER fabricated with silicon gate C²MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

It consists of two independent 4-bit counters, each composed of a divide-by-two and a divide-by-five counter. The divide-by-two counter is incremented on the negative going transition of clock A $(\overline{CKA}\,)$. The divided-by-five counter is incremented on the negative going transition of clock B $(\overline{CKB}\,)$. The counter can be cascaded to form decade, bi-quinary, or various combinations up to a divide-by-100 counter. When the CLR input is set high, the Q outputs are set to low independent of the clock inputs.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.



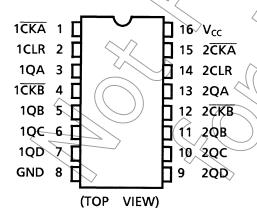


Weight SOL16-P-150-1.27 0.13 g (typ.)

Features

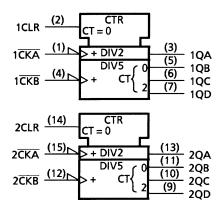
- High speed: $f_{max} = 84 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu A \text{ (max)}$ at $T_a = 25 \text{°C}$
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (min)
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: |IOH| = IOL = 4 mA (min)
- Balanced propagation delays: t_{pLH} \(\perp\) t_{pHL}
- Wide operating voltage range: VCC (opr) = 2/6 V
- Pin and function compatible with 74LS390

Pin Assignment

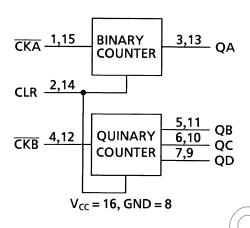


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IEC Logic Symbol



Block Diagram



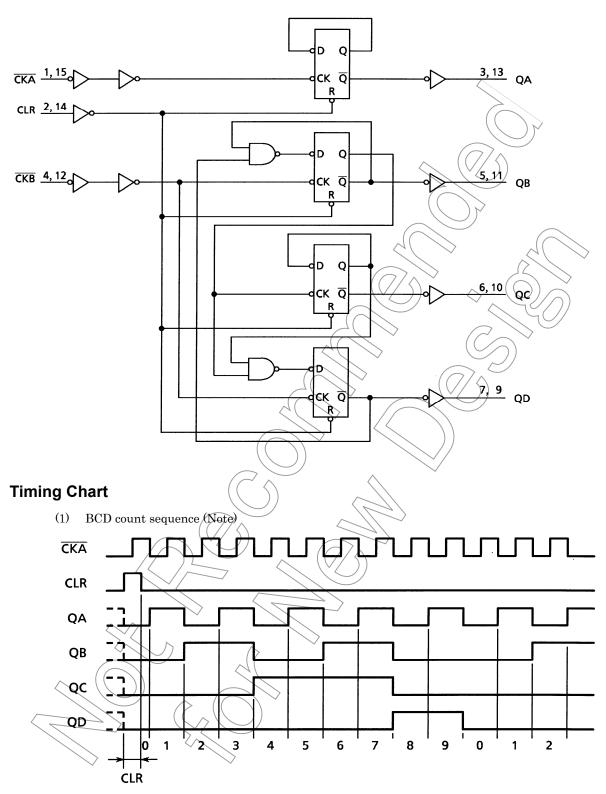
Truth Table

	Inputs		Outputs						
CKA	CKB	CLR	QA .	QB) Q	QD\			
Х	Х	Н	7/	⟨ L	L	L			
\neg	Х	L		Binary C	ount Up	//			
Х		$\langle 2 \rangle$	Quinary Count Up						
		/ /							

X: Don't care

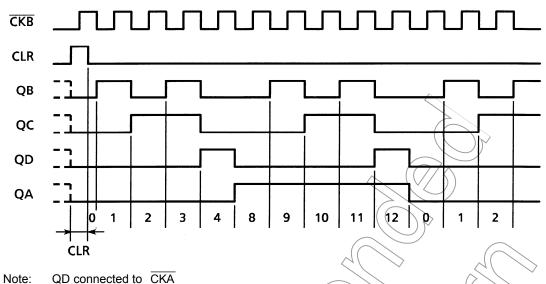
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System Diagram (1/2 package)



Note: QA connected to $\overline{\text{CKB}}$

(2) BI-quinary count sequence (Note)



Absolute Maximum Ratings (Note)

			/
Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	-0.5~7	\(\forall \bar{V}\)
DC input voltage	V _{IN}	-0.5~V _{CC} + 0.5	$\stackrel{\sim}{\sim}$
DC output voltage	V _{OUT}	0.5~V _{CC} + 0.5)) v
Input diode current	l _{IK}	±20	mA
Output diode current	lok	±20	mA
DC output current	Juol	±25	mA
DC V _{CC} /ground current	Ice	±50	mA
Power dissipation	(PD)	180	mW
Storage temperature	Tstg	65~150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2~6	٧
Input voltage	VIN	0~V _{CC}	٧
Output voltage	V _{OUT}	0~V _{CC}	٧
Operating temperature	T _{opr}	−40~85	°C
		0~1000 (V _{CC} = 2.0 V)	
Input rise and fall time	t _r , t _f	0~500 (V _{CC} = 4.5 V)	ns
		0~400 (V _{CC} = 6.0 V)	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40~85°C		Unit	
Characteristics	Symbol			V _{CC} (V)	Min	Тур.	Max	Min	Max	Unit
				2.0	1.50	- <	_	1.50	_	
High-level input voltage	V _{IH}		_	4.5	3.15	_ `	\nearrow	3.15	_	V
				6.0	4.20	_		4,20	_	
				2.0	_		0.50	<i>7</i> –	0.50	
Low-level input voltage	V _{IL}		_	4.5	~	$+\langle \cdot \rangle$	1.35	_	1.35	V
				6.0	->		1.80	_	1.80	
	V _{OH}	V _{IN} = V _{IH} or V _{IL}		2.0	1.9((2.0	· —	1.9	_	
			$I_{OH} = -20 \mu A$	4.5	4.4	4.5	_	4.4	_	
High-level output voltage				6.0	5.9	6.0	_	5.9	<u> </u>	V
			$I_{OH} = -4 \text{ mA}$	4.5	4.18	4.31	- (4.13	<u>~</u>	
			$I_{OH} = -5.2 \text{ mA}$	6.0	5.68	5.80	+c	5.63	>	
				2.0	<i>//</i>	0.0	0.1	(4)	0.1	
			I _{OL} = 20 μA	4.5	_	0.0	0.1		0.1	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	\mathcal{A}	6.0	_	0.0	0.7	× —	0.1	V
			I _{OL} = 4 mA	4.5	_	0.17	0.26	_	0.33	
			I _{OL} = 5.2 mA	6.0	_ ((0.18 <	0.26	_	0.33	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or	GND	6.0			±0.1	_	±1.0	μА
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or	GND	6.0)	4.0	_	40.0	μА

Timing Requirements (input: $t_r = t_f = 6$ ns)

9	ibati (i ti	7					
Characteristics	Symbol	Test Condition	Ta = 25°C		Ta = -40 ~85°C	Unit	
		(7/4)	V _{CC} (V)	Тур.	Limit	Limit	
Minimum pulse width			2.0	_	75	95	
(CK)	tw (H)		4.5	_	15	19	ns
(CK)	tw (L)		6.0	_	13	16	
Minimum nulae width			2.0	_	75	95	
Minimum pulse width	t _{W (H)}	_	4.5	_	15	19	ns
(CLR)	4		6.0	_	13	16	
		\rightarrow	2.0	_	25	30	
Minimum removal time	\(\frac{t_{rem}}{}\)	_	4.5	_	5	6	ns
			6.0	_	5	5	
Clock frequency			2.0	_	6	5	
(CKA)	f	_	4.5	_	32	26	MHz
(CKA)			6.0	_	38	31	
Clearly fraguency			2.0	_	6	5	
Clock frequency (CKB)	f	_	4.5	_	31	25	MHz
(CND)			6.0	_	36	29	

AC Characteristics (C_L = 15 pF, V_{CC} = 5 V, Ta = 25°C input: t_r = t_f = 6 ns)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Output transition time	t _{TLH}	_	_	4	8	ns
Carpat transition time	t _{THL}			7)	110
Propagation delay time	t _{pLH}			10	20	ns
(CKA -QA)	t _{pHL}	_	\sum	10	20	113
Propagation delay time	t _{pLH}	QA connected to CKB) >29	51	ns
(CKA -QC)	t _{pHL}	QA connected to CKB) 29	31	115
Propagation delay time	t _{pLH}	~ (7)	70	12	22	20
(CKB -QB, QD)	t _{pHL}	_		12	22	ns
Propagation delay time	t _{pLH}		>	17	32	ns
(CKB -QC)	t _{pHL}			17	32	115
Propagation delay time	.	7(>>		12	26	no
(CLR-Qn)	t _{pHL}		_ (₹0	ns
Maximum clock frequency		(7/4)	24		>	MILL
(CKA)	f _{max}		35	84) —	MHz
Maximum clock frequency			22	CE.		MU
(CKB)	f _{max}		33	<i>></i> 65	_	MHz



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AC Characteristics ($C_L = 50$ pF, input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -4	Unit	
Characteristics	Symbol		V _{CC} (V)	Min	Тур.	Max	Min	Max	Offic
	t		2.0	_	30	75	_	95	
Output transition time	t _{TLH}	_	4.5	_	8	15	_	19	ns
	t _{THL}		6.0	_	7 <	13	_	16	
Propagation delay	t _{pLH}		2.0	_	39	120	_	150	
time	t _{pHL}	_	4.5	_	13	24) >_	30	ns
(CKA -QA)	фиг		6.0	_	11	20		26	
Propagation delay	t _{pLH}		2.0	4	102/	290	_	365	
time	t _{pHL}	QA connected to CKB	4.5	$-\hat{c}$	34	58	_	73	ns
(CKA -QC)	фпг		6.0	-(29)	49	_	62	
Propagation delay	t_pLH		2.0		45	130		165	
time	t _{pHL}	_	4.5	/ \	√15	26	4	33	ns
(CKB -QB, QD)	-prii		6.0		13	22	$\langle - \rangle$	28	
Propagation delay time	t_pLH		2.0//)	63	185		230	
(CKB -QC)	t _{pHL}	_ (4.5	_	21	37	50	46	ns
(CKB-QC)	r		6.0	_	18	31	> =	39	
Propagation delay time			2,0	_	45	150	_	190	
(CLR-Qn)	t _{pHL}	- (4.5	_ (15	30	_	38	ns
(OLIV-QII)			6.0		V ₁ 3) 26	_	32	
Maximum clock frequency	•		2.0	6	20		5		
(CKA)	f _{max}		4.5	32	77		26	_	MHz
,			6.0	38	90		31		
Maximum clock frequency	f		2.0	6	15	_	5	_	NAL I—
($\overline{\text{CKB}}$)	f _{max}		6.0	32 36	60 70		25 29		MHz
Input capacitance	CILL	7/^	9.0	/ 30	5	10	29	10	pF
	CHN		$\overline{\wedge}$	_	3	10	_	10	ρı
Power dissipation capacitance	C _{PD} (Note)))	_	44	_	_	_	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

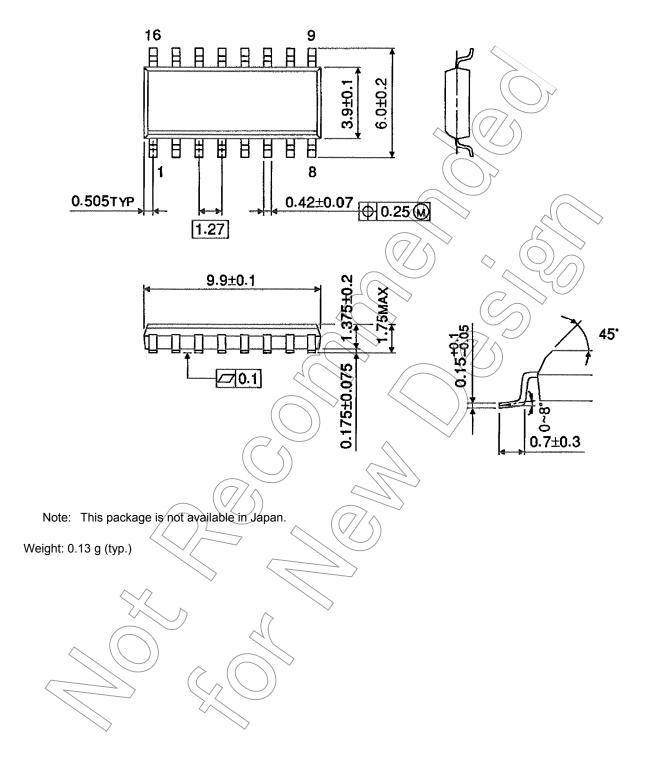
Average operating current can be obtained by the equation:



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Package Dimensions (Note)

SOL16-P-150-1.27 Unit: mm



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